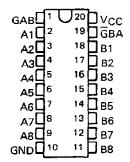
SDLS185

D2537, AUGUST 1979-REVISED MARCH 1988

- Bidirectional Bus Transceivers in High-Density 20-Pin Packages
- Local Bus-Latch Capability
- Hysteresis at Bus Inputs Improves Noise Margins
- Choice of True or Inverting Logic
- Choice of 3-State or Open-Collector Outputs

| DEVICE | OUTPUT         | LOGIC     |
|--------|----------------|-----------|
| 'LS620 | 3-State        | Inverting |
| 'LS621 | Open-Collector | True      |
| 4 6622 | 2 5+0+0        | Truo      |

SN54LS620, SN54LS621, SN54LS622...J PACKAGE SN74LS620, SN74LS621, SN74LS623...DW OR N PACKAGE (TOP VIEW)



#### description

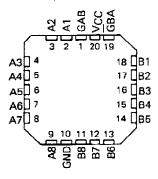
These octal bus transceivers are designed for asynchronous two-way communication between data buses. The control function implementation allows for maximum flexibility in timing.

These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the logic levels at the enable inputs ( $\overline{G}BA$  and GAB).

The enable inputs can be used to disable the device so that the buses are effectively isolated.

The dual-enable configuration gives the 'LS620, 'LS621, and 'LS623 the capability to store data by simultaneous enabling of  $\overline{G}BA$  and GAB. Each output reinforces its input in this transceiver configuration. Thus, when both control inputs are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (16 in all) will remain at their last states. The 8-bit codes appearing on the two sets of buses will be identical for the 'LS621 and 'LS623 devices or complementary for the 'LS620.

SN54LS620, SN54LS621, SN54LS622 . . . FK PACKAGE (TOP VIEW)



#### **FUNCTION TABLE**

| ENABLE | INPUTS | OPERA            | ATION            |
|--------|--------|------------------|------------------|
| ĞBA    | GAB    | 'LS620           | 'LS621, 'LS623   |
| L      | L      | B data to A bus  | B data to A bus  |
| Н      | H      | A data to B bus  | A data to B bus  |
| Н      | L      | Isolation        | Isolation        |
|        |        | B data to A bus, | B data to A bus, |
| L      | H      | A data to B bus  | A data to B bus  |

H = high level, L = low level

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) .    |         | <br> | <br> | . , | 7 V            |
|---------------------------------------|---------|------|------|-----|----------------|
| Input voltage                         |         | <br> | <br> |     | 7 V            |
| Off-state output voltage              |         |      |      |     |                |
| Operating free-air temperature range: | SN54LS' | <br> | <br> |     | –55°C to 125°C |
|                                       | SN74LS' | <br> | <br> | ,   | 0°C to 70°C    |
| Storage temperature range             |         | <br> | <br> |     | ~65°C to 150°C |

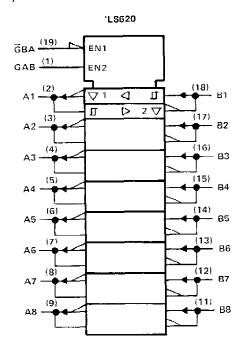
NOTE 1: Voltage values are with respect to network ground terminal.

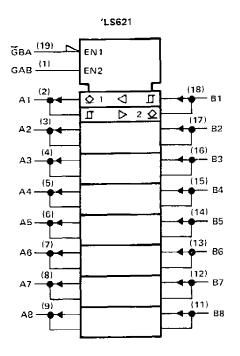
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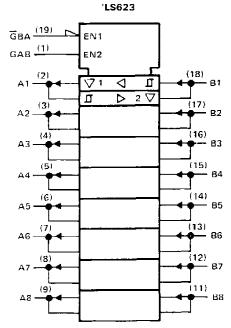


# SN54LS620, SN54LS621, SN74LS620, SN74LS621, SN74LS623 OCTAL BUS TRANSCEIVERS

## logic symbols†

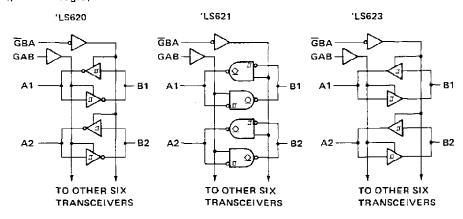




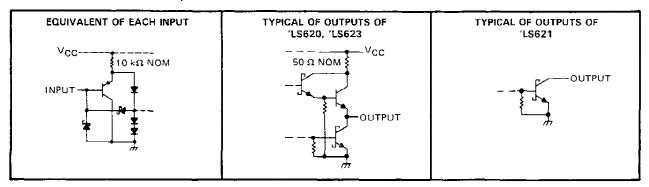


<sup>&</sup>lt;sup>†</sup> These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, and N packages.

## logic diagrams (positive logic)



### schematics of inputs and outputs



# SN54LS620, SN74LS620, SN74LS623 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

#### recommended operating conditions

| PARAMETER                                    | Si  | N54LS6 | 20  |      | N74LS6<br>N74LS6 |      | UNIT     |
|--|-----|--------|-----|------|------------------|------|----------|
|  | MIN | NOM    | MAX | MIN  | NOM              | MAX  |          |
| Supply voltage, V <sub>CC</sub> (see Note 1) | 4.5 | 5      | 5.5 | 4.75 | 5                | 5.25 | <u> </u> |
| High-level output current, IOH               |     |        | -12 |      |                  | -15  | mΑ       |
| Low-level output current, IOL                |     |        | 12  |      |                  | 24   | mΑ       |
| Operating free-air temperature, To           | -55 |        | 125 | 0    |                  | 70   | °c       |

NOTE 1: Voltage values are with respect to network ground terminal.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|       | PARAMETER   |                 | TEST CON  | DITIONS <sup>†</sup>    | sr  | 154LS6 | 20   |          | N74LS6<br>N74LS6 |      | UNIT     |
|-------|---|-----------------|---|-------------------------|-----|--------|------|----------|------------------|------|----------|
| ł     |   |                 |   |                         | MIN | TYPI   | MAX  | MIN      | TYP‡             | MAX  |          |
| VIH   | High-level input voltage                            |                 |   |                         | 2   |        |      | 2        |                  |      | V        |
| VIL   | Low-level input voltage                             |                 |   |                         |     |        | 0.5  |          |                  | 0.6  | V        |
| VIK   | Input clamp voltage                                 |                 | V <sub>CC</sub> = MIN,  | l <sub>1</sub> = −18 mA |     |        | -1.5 |          |                  | -1.5 | <u> </u> |
|       | Hysteresis (VT+ - VT_) A or                         | B input         | V <sub>CC</sub> = MIN   |                         | 0.1 | 0.4    |      | 0.2      | 0.4              |      |          |
| .,    |   | · · · · · ·     | VCC = MIN,  | I <sub>OH</sub> = -3 mA | 2.4 | 3.4    |      | 2.4      | 3.4              |      | v        |
| ∨он   | High-level output voltage                           |                 | V <sub>IH</sub> = 2 V,<br>V <sub>IL</sub> = V <sub>IL</sub> max   | I <sub>OH</sub> = MAX   | 2   |        |      | 2        |                  |      |          |
|       | 1 1 1 1 1 1   |                 | VCC = MIN,  | I <sub>OL</sub> = 12 mA |     | 0.25   | 0.4  |          | 0.25             | 0.4  | v        |
| VOL   | Low-level output voltage                            |                 | V <sub>IH</sub> = 2 V,<br>  V <sub>IL</sub> = V <sub>IL</sub> max | IQL = 24 mA             |     |        |      |          | 0.35             | 0.5  |          |
| lozh  | Off-state output current,                           |                 | VCC = MAX,  | G at 2 V,               |     |        | 20   | •        |                  | 20   | μА       |
| .0217 | high-level voltage applied                          |                 | V <sub>O</sub> = 2.7 V  |                         | ļ   |        |      |          |                  |      | ļ        |
| lozL  | Off-state output current, low-level voltage applied |                 | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 0.4 V                  | Gat2∨,                  |     |        | -400 |          |                  | 400  | μА       |
|       | Input current at                                    | A or B          | 1   | V₁ = 5.5 V              |     |        | 0.1  |          |                  | 0.1  | mA       |
| 14    | maximum input voltage                               | GBA or GAB      | VCC = MAX,  | V <sub>1</sub> = 7 V    |     |        | 0.1  |          |                  | 0.1  | IDA      |
| ΊΗ    | High-level input current                            |                 | V <sub>CC</sub> = MAX,  | V <sub>1</sub> = 2.7 V  |     |        | 20   |          |                  | 20   | μA       |
| TiL   | Law-level input current                             |                 | V <sub>CC</sub> = MAX,  | V <sub>I</sub> = 0.4 V  |     |        | -0.4 |          |                  | -0.4 | mA       |
| los   | Short-circuit output current §                      |                 | VCC = MAX   |                         | -40 |        | -225 | -40      |                  | -225 | mA       |
|       |   | Outputs high    |   |                         |     | 48     | 70   |          | 48               | 70   | ↓        |
| Icc   | Total supply current                                | Outputs low     | $V_{CC} = MAX$ ,  | Outputs open            |     | 62     | 90   |          | 62               | 90   | mA       |
|       |   | Outputs at Hi-Z |   |                         |     | 64     | 95   | <u>L</u> | 64               | 95   |          |

For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions.

## switching characteristics at VCC = 5 V, TA = 25°C

|                  | PARAMETER                           | FROM    | то       | TEST CONDITIONS         | ,   | LS620 |     | SN  | 74LS6 | 523 | UNIT     |
|------------------|-------------------------------------|---------|----------|-------------------------|-----|-------|-----|-----|-------|-----|----------|
|                  |                                     | (INPUT) | (OUTPUT) |                         | MIN | TYP   | MAX | MIN | TYP   | MAX | <u> </u> |
|                  | Propagation delay time,             | Α       | В        |                         |     | 6     | 10  |     | 8     | 15  | ns       |
| ₹₽LH             | low-to-high-level output            | В       | Α        | 0 - 46 - 5              |     | 6     | 10  |     | 8     | 15  | 1113     |
|                  | Propagation delay time,             | A       | В        | CL = 45 pF.             |     | 8     | 15  |     | 11    | 15  | ns       |
| t₽HĻ             | high-to-low-level output            | В       | Α        | D 007.0                 |     | 8     | 15  |     | 11    | 15  | 113      |
|                  |                                     | ĞВА     | Α        | R <sub>L</sub> = 667 Ω, |     | 31    | 40  |     | 31    | 40  | ns       |
| tbZT             | Output enable time to low level     | GA8     | В        |                         |     | 31    | 40  |     | 31    | 40  | 1115     |
|                  |                                     | GBA     | А        | See Note 2              |     | 23    | 40  |     | 26    | 40  | ns       |
| <sup>t</sup> PZH | Output enable time to high level    | GAB     | В        | i                       |     | 23    | 40  |     | 26    | 40  | 1113     |
|                  | 0                                   | ĞВА     | A        | 0 5.5                   |     | 15    | 25  |     | 15    | 25  |          |
| <sup>t</sup> PLZ | Output disable time from low level  | GAB     | В        | CL = 5 pF,              |     | 15    | 25  |     | 15    | 25  | ns       |
|                  | <u> </u>                            | ĞВА     | A        | AL = 667 Ω,             |     | 15    | 25  |     | 15    | 25  |          |
| tPHZ             | Output disable time from high level | GAB     | В        | See Note 2              |     | 15    | 25  |     | 15    | 25  | ns _     |

 $t_{\text{PLH}}$  = Propagation delay time, low-to-high-level output

tpZL = Output enable time to low level tpHZ = Output disable time from high level

tpLZ = Output disable time from low level



 $<sup>\</sup>ddagger$ All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

tpHL = Propagation delay time, high-to-low-level output tpZH = Output enable time to high level

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

# recommended operating conditions

| PARAMETER                                    | s   | \$N54LS621 |     |      | SN74LS621 |      |    |  |
|--|-----|------------|-----|------|-----------|------|----|--|
|  | MIN | NOM        | MAX | MIN  | NOM       | MAX  | 1  |  |
| Supply voltage, V <sub>CC</sub> (see Note 1) | 4.5 | 5          | 5.5 | 4.75 | 5         | 5.25 | V  |  |
| High-level output voltage, V <sub>OH</sub>   |     |            | 5.5 |      |           | 5.5  | V  |  |
| Law-level output current, IOL                |     |            | 12  |      |           | 24   | mA |  |
| Operating free-air temperature, TA           | 55  |            | 125 | 0    |           | 70   | ·c |  |

NOTE 1: Voltage values are with respect to network ground terminal.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|          | PARAMETER   |                | TEST CON   | DITIONS <sup>‡</sup>    | S   | N54LS6 | 521  | SI  | 521  | ⊤ואט |       |
|----------|---|----------------|--|-------------------------|-----|--------|------|-----|------|------|-------|
|          |   |                |  |                         | MIN | TYP‡   | MAX  | MIN | TYP‡ | MAX  |       |
| $V_{IH}$ | High-level input voltage                          |                |  |                         | 2   |        |      | 2   |      |      | V     |
| ۷۱L      | Low-level input voltage                           | · <del>-</del> |  |                         |     |        | 0.5  |     |      | 0.6  | V     |
| VIK      | înput clamp voltage                               |                | VCC = MIN,   | I <sub>I</sub> = -18 mA |     |        | 1.5  |     | '    | -1.5 | V     |
|          | Hysteresis (V <sub>T+</sub> - V <sub>T-</sub> ) A | or B input     | V <sub>CC</sub> = MIN  |                         | 0.1 | 0.4    |      | 0.2 | 0.4  |      | V     |
| Іон      | High-level output current                         |                | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = V <sub>IL</sub> max, | •••                     |     |        | 100  |     |      | 100  | μА    |
| VoL      | Low-level output voltage                          |                | V <sub>CC</sub> = MIN,<br>V <sub>IH</sub> = 2 V,                 | I <sub>OL</sub> = 12 mA |     | 0.25   | 0.4  |     | 0,25 | 0.4  | V     |
|          | -   |                | V <sub>IL</sub> = V <sub>IL</sub> max                            | IOL = 24 mA             |     |        |      |     | 0.35 | 0.5  |       |
| l.       | Input current at                                  | A or B         | 11 1141  | 5.5 V                   |     |        | 0.1  |     |      | 0.1  | ^     |
| Ц        | maximum input voltage                             | GAB or GBA     | $V_{CC} = MAX$ ,   | V1 = 7 V                |     |        | 0.1  |     |      | 0.1  | mA    |
| ¹1H      | High-level input current                          |                | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 2.7 V  |     |        | 20   |     |      | 20   | μА    |
| IL       | Low-level input current                           |                | VCC = MAX,   | V <sub>I</sub> = 0.4 V  | Ī   |        | -0.4 |     |      | -0.4 | : mA  |
| lcc      | Total supply current                              | Outputs high   | VCC = MAX,   | Outputs open            |     | 48     | 70   |     | 48   | 70   | mA    |
| .00      | rotal supply current                              | Outputs low    | ACC - MAY  | Outpots open            |     | 62     | 90   |     | 62   | 90   | ] ''' |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25 \,^{\circ}\text{C}$

|                  | PARAMETER                | FROM    | то       | TEST CONDITIONS                       |     | 'LS621 |     | UNIT |
|------------------|--------------------------|---------|----------|---------------------------------------|-----|--------|-----|------|
|                  | PARAMETER                | {INPUT} | (OUTPUT) | TEST CONDITIONS                       | MIN | TYP    | MAX | UNIT |
| •                | Propagation delay time,  | А       | В        |                                       |     | 17     | 25  |      |
| †PLH             | low-to-high-level output | В       | Α        | 1                                     |     | 17     | 25  | ns   |
|                  | Propagation delay time,  | Α       | В        | 1                                     |     | 16     | 25  |      |
| 1PHL             | high-to-law-level output | В       | А        | $C_L = 45 \text{ pF},$                |     | 16     | 25  | ns   |
| •                | Output disable time      | Ğва     | А        | R <sub>L</sub> = 667 Ω,<br>See Note 2 |     | 23     | 40  |      |
| <sup>†</sup> PLH | from law level           | GAB     | В        | See Note 2                            |     | 25     | 40  | ns   |
|                  | Output enable time       | GBA     | А        |                                       |     | 34     | 50  |      |
| tPHL.            | from high level          | GAB     | В        |                                       |     | 37     | 50  | ПБ   |

tPLH = Propagation delay time, low-to-high-level output

tpHL = Propagation delay time, high-to-low-level output

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

 $<sup>\</sup>ddagger$ All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

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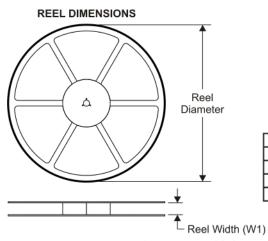
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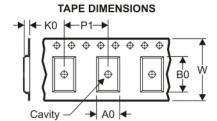
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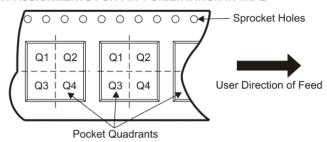
## TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
|    | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



### \*All dimensions are nominal

| Device       |      | Package<br>Drawing |    |      | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------|------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74LS623DWR | SOIC | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8    | 13.0    | 2.7     | 12.0       | 24.0      | Q1               |
| SN74LS623NSR | SO   | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.2     | 13.0    | 2.5     | 12.0       | 24.0      | Q1               |





\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS623DWR | SOIC         | DW              | 20   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74LS623NSR | SO           | NS              | 20   | 2000 | 346.0       | 346.0      | 41.0        |

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